

Part Number: 1717222101

Product Description: zQuad Small Form Factor Pluggable Plus (zQSFP+) Stacked Integrated 2-by-2 Connector and Cage with Metal EMI Gasket, Gold (Au) Over Nickel

Plated

Series Number: 171722

**Status:** Active

Product Category: High-Speed I/O

Connectors



#### **Documents & Resources**

### **Drawings**

Drawing 1717222101\_sd.pdf
Packaging Design Drawing PK-171565-0001-001.pdf

### 3D Models and Design Files

Electrical Model Document EE-171081-3000-001.pdf S-Parameter Model SP-171081-3000-001.zip

#### **Specifications**

Application Specification AS-171565-0002-001.pdf Product Specification PS-171565-0001-001.pdf Test Summary TS-171565-0001-001.pdf

## **Product Environment Compliance**

### Compliance

GADSL/IMDS	Not Relevant
China RoHS	<b>©</b>
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)4144-DC (27 June 2024)
EU RoHS	Compliant per EU 2015/863

#### Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC

## - Low-Halogen

## Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

## EU RoHS Certificate of Compliance

## **Part Details**

## General

Status	Active
Category	High-Speed I/O Connectors
Series	171722
Description	zQuad Small Form Factor Pluggable Plus (zQSFP+) Stacked Integrated 2- by-2 Connector and Cage with Metal EMI Gasket, Gold (Au) Over Nickel Plated
Application	Board-to-Board, Module-to-Board, Wire-to-Board
Component Type	Receptacle
Product Family	zQSFP+ and QSFP+ Integrated Product Solutions
Product Name	zQSFP Plus,zQSFP+
Туре	Pluggable
UPC	887191735368

## Agency

UL E29179
-----------

#### **Electrical**

Current - Maximum per Contact	0.5A
Data Rate	28.0 Gbps
Grounding to Panel	Yes
Shield Type	EMI Gasket
Voltage - Maximum	30V AC (RMS)/DC

# Physical

Circuits (Loaded)	152
Circuits (maximum)	152
Color - Resin	Black
Durability (mating cycles max)	100
Flammability	94V-0
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Matte Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	62.211/g
Number of Rows	2
Orientation	Right Angle
Packaging Type	Tray
Panel Mount	N/A
PC Tail Length	1.20mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Pitch - Mating Interface	0.80mm
Plating min - Mating	0.762µm
Plating min - Termination	0.762µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	4
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Through Hole - Compliant Pin

# Solder Process Data

Lead-Free Process Capability	N/A
------------------------------	-----

# Mates With / Use With

## Mates with Part(s)

Description	Part Number
QSFP Cable Assemlies	<u>74757</u>

This document was generated on Sep 20, 2024